LM129/LM329 Precision Reference

General Description

The LM129 and LM329 family are precision multi-current temperature-compensated 6.9V zener references with dynamic impedances a factor of 10 to 100 less than discrete diodes. Constructed in a single silicon chip, the LM129 uses active circuitry to buffer the internal zener allowing the device to operate over a 0.5 mA to 15 mA range with virtually no change in performance. The LM129 and LM329 are available with selected temperature coefficients of 0.001, 0.002, 0.005 and 0.01%/°C. These new references also have excellent long term stability and low noise.

A new subsurface breakdown zener used in the LM129 gives lower noise and better long-term stability than conventional IC zeners. Further the zener and temperature compensating transistor are made by a planar process so they are immune to problems that plague ordinary zeners. For example, there is virtually no voltage shift in zener voltage due to temperature cycling and the device is insensitive to stress on the leads.

The LM129 can be used in place of conventional zeners with improved performance. The low dynamic impedance

simplifies biasing and the wide operating current allows the replacement of many zener types.

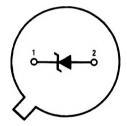
The LM129 is packaged in a 2-lead TO-46 package and is rated for operation over a -55°C to $+125^{\circ}\text{C}$ temperature range. The LM329 for operation over 0°C to 70°C is available in both a hermetic TO-46 package and a TO-92 epoxy package.

Features

- 0.6 mA to 15 mA operating current
- 0.6Ω dynamic impedance at any current
- Available with temperature coefficients of 0.001%/°C
- 7µV wideband noise
- 5% initial tolerance
- 0.002% long term stability
- Low cost
- Subsurface zener

Connection Diagrams

Metal Can Package (TO-46)



Bottom View

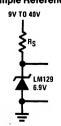
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Pin 2 is electrically connected to case

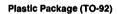
Order Number LM129AH, LM129AH/883, LM129BH, LM129BH/883, LM129CH, LM329AH, LM329BH, LM329CH or LM329DH See NS Package H02A

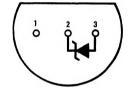
Typical Applications

Simple Reference



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Bottom View

Order Number LM329BZ, LM329CZ or LM329DZ See NS Package Z03A

Absolute Maximum Ratings

If Military/Aerospace specified devices are required, please contact the National Semiconductor Sales Office/Distributors for availability and specifications. (Note 2)

Reverse Breakdown Current

30 mA

-55°C to +125°C

Forward Current

Operating Temperature Range

LM129 LM329

2 mA

0°C to +70°C

Storage Temperature Range

Soldering Information TO-92 package: 10 sec.

TO-46 package: 10 sec.

-55°C to +150°C

260°C 300°C

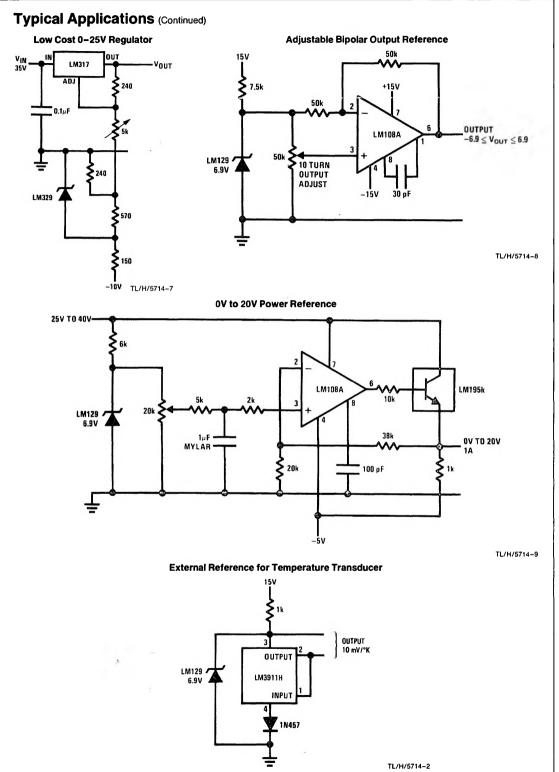
Electrical Characteristics (Note 1)

Parameter	Conditions	LM129A, B, C			LM329A, B, C, D			Units
		Min	Тур	Max	Min	Тур	Max	
Reverse Breakdown Voltage	$T_A = 25^{\circ}C$, 0.6 mA $\leq I_R \leq 15$ mA	6.7	6.9	7.2	6.6	6.9	7.25	V
Reverse Breakdown Change with Current (Note 3)	$T_A = 25^{\circ}C$, 0.6 mA $\leq I_R \leq 15$ mA	- j 00	9	14		9	20	mV
Reverse Dynamic Impedance (Note 3)	T _A = 25°C, I _R = 1 mA	*	0.6	1		0.8	2	Ω
RMS Noise	$T_A = 25^{\circ}C$, 10 Hz $\leq F \leq$ 10 kHz	- Y-	7	20		7	100	μ۷
Long Term Stability (1000 hours)	$T_A = 45^{\circ}C \pm 0.1^{\circ}C,$ $I_R = 1 \text{ mA} \pm 0.3\%$		20			20		ppm
Temperature Coefficient LM129A, LM329A LM129B, LM329B LM129C, LM329C LM329D	! _R = 1 mA ·		6 15 30	10 20 50		6 15 30 50	10 20 50 100	ppm/°(ppm/°(ppm/°(ppm/°(
Change In Reverse Breakdown Temperature Coefficient	1 mA ≤ I _R ≤ 15 mA		1	- 1		1		ppm/°
Reverse Breakdown Change with Current	1 mA ≤ I _R ≤ 15 mA		12			12		mV
Reverse Dynamic Impedance	1 mA ≤ I _R ≤ 15 mA		0.8	1		1		Ω

Note 1: These specifications apply for -55° C $\leq T_{A} \leq +125^{\circ}$ C for the LM129 and 0° C $\leq T_{A} \leq +70^{\circ}$ C for the LM329 unless otherwise specified. The maximum junction temperature for an LM129 is 150°C and LM329 is 100°C. For operating at elevated temperature, devices in TO-46 package must be derated based on a thermal resistance of 440°C/W junction to ambient or 80°C/W junction to case. For the TO-92 package, the derating is based on 180°C/W junction to ambient with 0.4" leads from a PC board and 160°C/W junction to ambient with 0.125" lead length to a PC board.

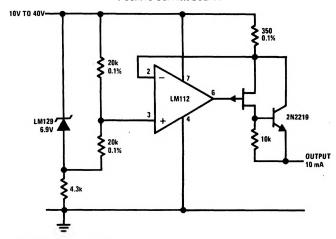
Note 2: Refer to RETS129H for LM129 family military specifications.

Note 3: These changes are tested on a pulsed basis with a low duty-cycle. For changes versus temperature, compute in terms of tempco.



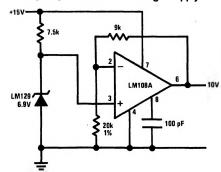
Typical Applications (Continued)

Positive Current Source



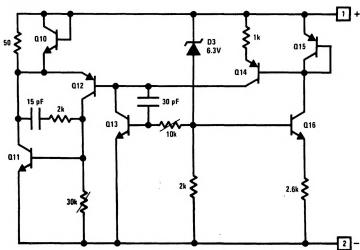
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Buffered Reference with Single Supply



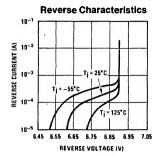
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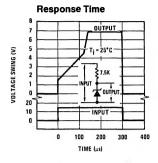
Schematic Diagram

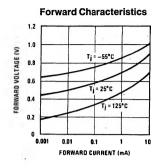


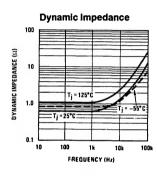
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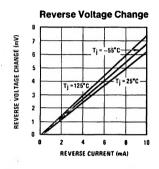
Typical Performance Characteristics

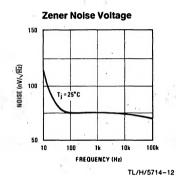


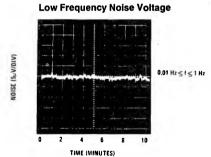












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